

FEATURES

Low profile package

I Ideal for automated placement

Glass passivated Junction chip

High forward surge current capability





APPLICATIONS

For use in general purpose rectification of power supplies,	
inverters, converters, and freewheeling diodes for consumer	
and telecommunication	

APPROVALS

RoHS	Compliance with 2011/65/EU
HF	Compliance with IEC61249-2-21:2003

MAXIMUM RATINGS AND CHARACTERISTICS ($T_A = 25$ °C)

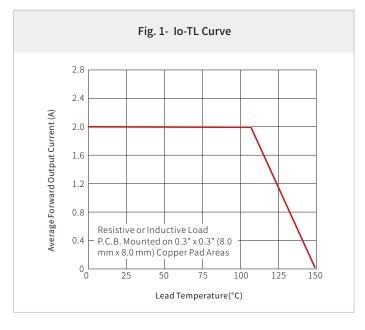
Parameter		Symbol	GS2AB	GS2BB	GS2DB	GS2GB	GS2JB	GS2KB	GS2MB	Unit	
Marking			GS2A	GS2B	GS2D	GS2G	GS2J	GS2K	GS2M		
Maximum Repetitive Peak Reverse Vol	tage	$V_{_{RRM}}$	50	100	200	400	600	800	1000		
Maximum RMS Voltage		V_{RMS}	35	70	140	280	420	560	700	V	
Maximum DC Blocking Voltage		V _{DC}	50	100	200	400	600	800	1000		
Average Rectified Output Current @60hz Sine Wave, Resistance Load, TL	(Fig.1)	I _o	2								
Forward Surge Current (Non-Repetitive) @60hz Half-Sine Wave,1 Cycle, Tj=25°C Forward Surge Current (Non-Repetitive) @1ms, Square Wave, 1 Cycle, Tj=25°C		I _{FSM}				50 100				А	
Maximum Instantaneous Forward Voltage I _{FM} =2.0A		V _F	1.1						V		
Maximum DC Reverse Current at	T _J =25°C					5.0					
Rated DC Blocking Voltage	T _J =125°C	I _R	100							μΑ	
Typical Junction Capacitance Measured At 1mhz and Applied Reverse Voltage Of 4.0 V.D.C		CJ				12				pF	
Current Squared Time @1ms≤t≤8.3ms Tj=25°C		l²t	10.735						A ² s		
Typical Thermal Resistance (1)		$R_{\theta J-A}$				60					
		$R_{\theta J-L}$				20				°C/W	
		$R_{_{\theta J\text{-}C}}$				15					
Operating Junction and Storage Temp	erature Range	$T_{J},\!T_{STG}$			-55	to +150				°C	

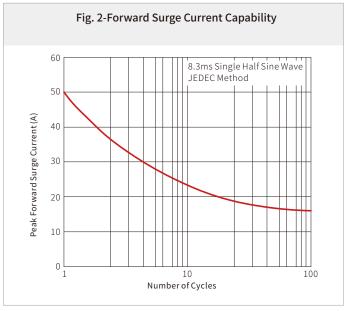
Note:

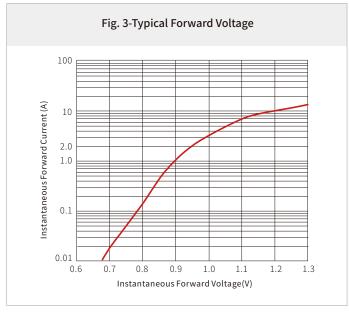
(1) Thermal Resistance From Junction to Ambient and From Junction to Lead Mounted On P.C.B. With 0.3" X 0.3" (8.0 mm X 8.0 mm) Copper Pad Areas

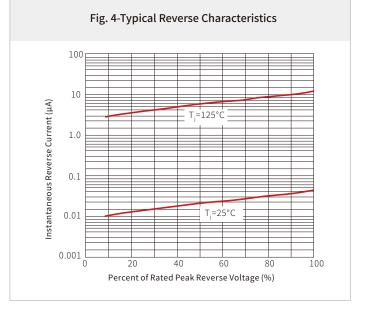


CHARACTERISTIC CURVES





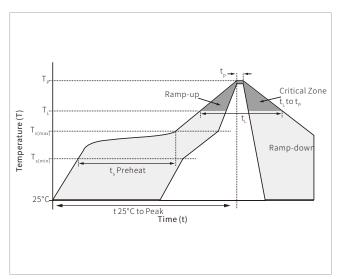




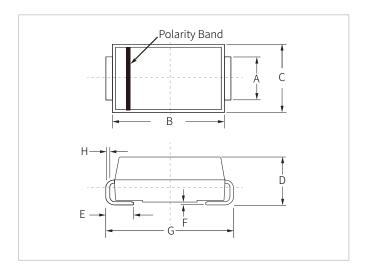


SOLDERING PARAMETERS

	Lead-free assembly			
	Temperature Max (T _{s(min)})	150°C		
Pre Heat	Temperature Max (T _{s(max)})	200°C		
	Time (min to max) (t _s)	60 – 180 secs		
Average ran	Average ramp up rate (Liquidus Temp (T_L) to peak			
	3°C/second max			
Reflow	Temperature (T _L) (Liquidus)	217°C		
Reliow	Time (min to max) (t _L)	60 – 150 seconds		
Peak Temp	260°C			
Time within	20 – 40 seconds			
Ramp-dow	6°C/second max			
Time 25°C t	8 minutes max.			
Do not exce	260°C			



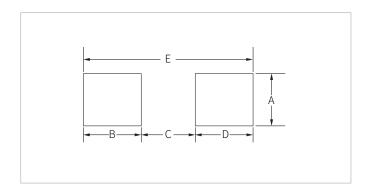
DO-214AA(SMB) PACKAGE INFORMATION



Ref.	MILLIIT	ieters	inches		
ici.	Min.	Max.	Min.	Max.	
А	1.80	2.20	0.071	0.087	
В	4.30	4.70	0.170	0.185	
С	3.40	3.90	0.134	0.153	
D	2.15	2.75	0.085	0.108	
Е	1.00	1.50	0.039	0.059	
F	0.02	0.20	0.001	0.008	
G	5.10	5.50	0.200	0.216	
Н	0.15	0.30	0.006	0.012	



RECOMMENDED PAD LAYOUT DIMENSIONS



Ref.	Millin	neters	Inches		
KCI.	Min.	Max.	Min.	Max.	
А	2.20	-	0.087	-	
В	1.45	-	0.057	-	
С	-	2.55	-	0.010	
D	1.45	-	0.057	-	
Е	5.60REF		0.22	0REF	

ORDERING INFORMATION

Part Number	Component Package	QTY/Reel	Reel Size
GS2AB-GS2MB	DO-214AA(SMB)	3000PCS	13"



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